| Electronic Patent Application Fee Transmittal | | | | | | | |
|--|--------------------------------------|--|----------|--------|-------------------------|--|--|
| Application Number: | 105 | 10522502 | | | | | |
| Filing Date: | 11- | 11-Nov-2005 | | | | | |
| Title of Invention: | Ser | Semiconductor wafer with electrically connected contact and test areas | | | | | |
| First Named Inventor/Applicant Name: | Werner Ertle | | | | | | |
| Filer: | Steven Edward Dicke/Connie Scheff MG | | | | | | |
| Attorney Docket Number: | I431.124.101/ | | | | | | |
| Filed as Large Entity | | | | | | | |
| U.S. National Stage under 35 USC 371 Filing Fees | | | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | |
| Basic Filing: | | | | | | | |
| Pages: | | | | | | | |
| Claims: | | | | | | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Extension-of-Time: | | | | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-----------------------------------|----------|----------|--------|-------------------------|
| Miscellaneous: | | | | |
| Request for continued examination | 1801 | 1 | 810 | 810 |
| | Tot | 810 | | |